

July 2013

2N3906 / MMBT3906 / PZT3906 PNP General Purpose Amplifier

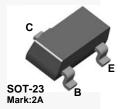
Description

This device is designed for general purpose amplifier and switching applications at collector currents of 10 mA to 100 mA.

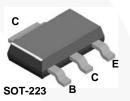




MMBT3906



PZT3906



Ordering Information

| Part Number | Marking | Package | Packing Method | Pack Quantity |
|-------------|---------|---------|----------------|---------------|
| 2N3906BU | 2N3906 | TO-92 | BULK | 10000 |
| 2N3906TA | 2N3906 | TO-92 | AMMO | 2000 |
| 2N3906TAR | 2N3906 | TO-92 | AMMO | 2000 |
| 2N3906TF | 2N3906 | TO-92 | TAPE REEL | 2000 |
| 2N3906TFR | 2N3906 | TO-92 | TAPE REEL | 2000 |
| MMBT3906 | 2A | SOT-23 | TAPE REEL | 3000 |
| PZT3906 | 3906 | SOT-223 | TAPE REEL | 2500 |

Absolute Maximum Ratings(1)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25$ °C unless otherwise noted.

| Symbol | Parameter | Value | Units |
|----------------------------------|--|-------------|-------|
| V _{CEO} | Collector-Emitter Voltage | -40 | V |
| V _{CBO} | Collector-Base Voltage | -40 | V |
| V _{EBO} | Emitter-Base Voltage | -5.0 | V |
| I _C | Collector Current - Continuous | -200 | mA |
| T _{J,} T _{stg} | Operating and Storage Junction Temperature Range | -55 to +150 | °C |

Note:

1. These ratings are based on a maximum junction temperature of 150 °C.

These are steady-state limits. Fairchild Semiconductor should be consulted on applications involving pulsed or low-duty cycle operations.

Thermal Characteristics

Values are at $T_A = 25$ °C unless otherwise noted.

| Symbol | Parameter | Max. | | | Units |
|-----------------|---|--------|-------------------------|------------------------|--------|
| | | 2N3906 | MMBT3906 ⁽²⁾ | PZT3906 ⁽³⁾ | Office |
| В | Total Device Dissipation | 625 | 350 | 1,000 | mW |
| P_{D} | Derate above 25°C | 5.0 | 2.8 | 8.0 | mW/°C |
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case | 83.3 | | | °C/W |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient | 200 | 357 | 125 | °C/W |

Notes:

- 2. Device mounted on FR-4 PCB 1.6 inch X 1.6 inch X 0.06 inch.
- 3. Device mounted on FR-4 PCB 36 mm X 18 mm X 1.5 mm; mounting pad for the collector lead minimum 6 cm².

Electrical Characteristics

Values are at $T_A = 25$ °C unless otherwise noted.

| Symbol | Parameter | Test Condition | Min. | Max. | Units |
|----------------------|---|---|-------|-------|-------|
| OFF CHAR | ACTERISTICS | | | | • |
| V _{(BR)CEO} | Collector-Emitter Breakdown Voltage ⁽⁴⁾ | I _C = -1.0 mA, I _B = 0 | -40 | | V |
| V _{(BR)CBO} | Collector-Base Breakdown Voltage | $I_C = -10 \mu\text{A}, I_E = 0$ | -40 | | V |
| V _{(BR)EBO} | Emitter-Base Breakdown Voltage | $I_E = -10 \mu A, I_C = 0$ | -5.0 | | V |
| I _{BL} | Base Cutoff Current | $V_{CE} = -30 \text{ V}, V_{BE} = 3.0 \text{ V}$ | | -50 | nA |
| I _{CEX} | Collector Cutoff Current | $V_{CE} = -30 \text{ V}, V_{BE} = 3.0 \text{ V}$ | | -50 | nA |
| | CTERISTICS | | I. | | |
| | | $I_C = -0.1 \text{ mA}, V_{CE} = -1.0 \text{ V}$ | 60 | | |
| | | $I_C = -1.0 \text{ mA}, V_{CE} = -1.0 \text{ V}$ | 80 | | |
| h_{FE} | DC Current Gain ⁽⁴⁾ | $I_C = -10 \text{ mA}, V_{CE} = -1.0 \text{ V}$ | 100 | 300 | |
| 1. | | $I_C = -50 \text{ mA}, V_{CE} = -1.0 \text{ V}$ | 60 | | |
| | | $I_C = -100 \text{ mA}, V_{CE} = -1.0 \text{V}$ | 30 | | |
| V/ | Collector-Emitter Saturation Volt- | $I_C = -10 \text{ mA}, I_B = -1.0 \text{ mA}$ | | -0.25 | V |
| V _{CE(sat)} | age | $I_C = -50 \text{ mA}, I_B = -5.0 \text{ mA}$ | | -0.4 | V |
| | Base-Emitter Saturation Voltage | I _C = -10 mA, I _B = -1.0 mA | -0.65 | -0.85 | V |
| V _{BE(sat)} | | $I_C = -50 \text{ mA}, I_B = -5.0 \text{ mA}$ | | -0.95 | V |
| SMALL SIG | NAL CHARACTERISTICS | | | | |
| f _T | Current Gain - Bandwidth Product | $I_C = -10 \text{ mA}, V_{CE} = -20 \text{ V},$ f = 100 MHz | 250 | | MHz |
| C _{obo} | Output Capacitance | $V_{CB} = -5.0 \text{ V}, I_{E} = 0,$ f = 100 kHz | | 4.5 | pF |
| C _{ibo} | Input Capacitance | $V_{EB} = -0.5 \text{ V}, I_{C} = 0,$ f = 100 kHz | | 10.0 | pF |
| NF | Noise Figure | I_C = -100 μA, V_{CE} = -5.0 V, R_S = 1.0 kΩ, f = 10 Hz to 15.7 kHz | | 4.0 | dB |
| SWITCHING | CHARACTERISTICS | | | | |
| t _d | Delay Time | $V_{CC} = -3.0 \text{ V}, V_{BE} = -0.5 \text{ V}$ | | 35 | ns |
| t _r | Rise Time | $I_C = -10 \text{ mA}, I_{B1} = -1.0 \text{ mA}$ | | 35 | ns |
| t _s | Storage Time | $V_{CC} = -3.0 \text{ V}, I_{C} = -10 \text{ mA},$ | A | 225 | ns |
| t _f | Fall Time | $I_{B1} = I_{B2} = -1.0 \text{ mA}$ | | 75 | ns |

Note:

4. Pulse Test: Pulse Width $\leq 300 \mu s,$ Duty Cycle $\leq 2.0 \%.$

Typical Performance Characteristics

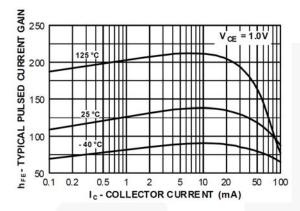


Figure 1. Typical Pulsed Current Gain vs. Collector Current

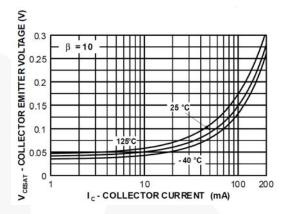


Figure 2. Collector-Emitter Saturation Voltage vs.
Collector Current

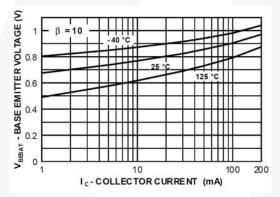


Figure 3. Base-Emitter Saturation Voltage vs. Collector Current

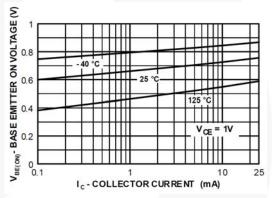


Figure 4. Base-Emitter On Voltage vs. Collector Current

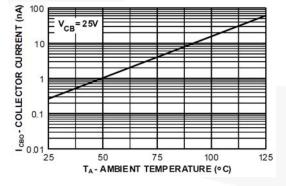


Figure 5. Collector Cut-Off Current vs. Ambient Temperature

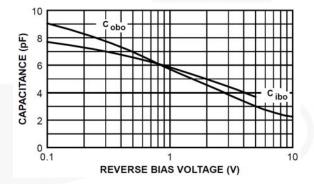


Figure 6. Common-Base Open Circuit Input and Output Capacitance vs. Reverse Bias Voltage

Typical Performance Characteristics (continued)

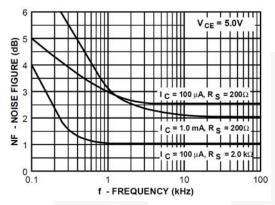


Figure 7. Noise Figure vs. Frequency

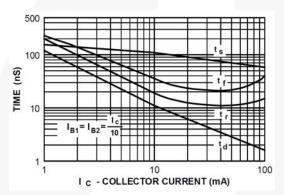


Figure 9. Switching Times vs. Collector Current

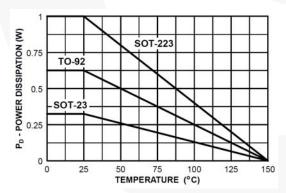


Figure 11. Power Dissipation vs. Ambient Temperature

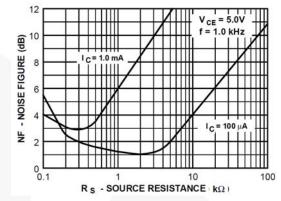


Figure 8. Noise Figure vs. Source Resistance

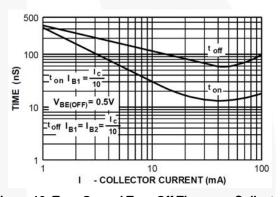


Figure 10. Turn On and Turn Off Times vs. Collector Current

Typical Performance Characteristics (continued)

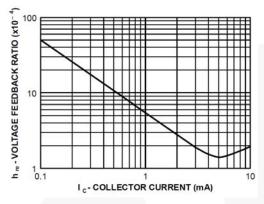


Figure 12. Voltage Feedback Ratio

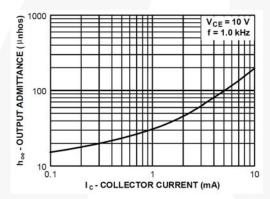


Figure 14. Output Admittance

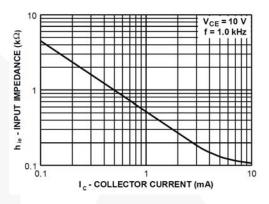


Figure 13. Input Impedance

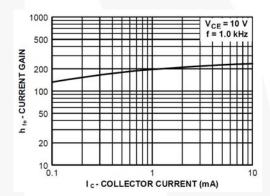


Figure 15. Current Gain

Physical Dimensions

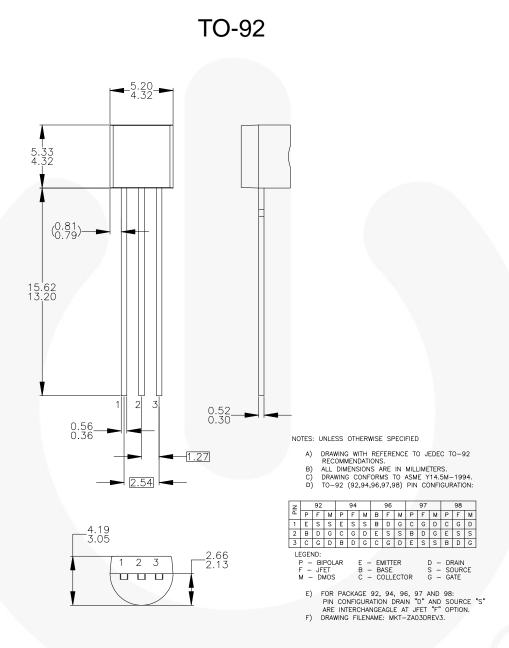


Figure 16. 3-LEAD, TO92, MOLDED 0.200 IN LINE SPACING LD FORM (J61Z OPTION) (ACTIVE)

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Physical Dimensions (continued)

SOT-223 4L

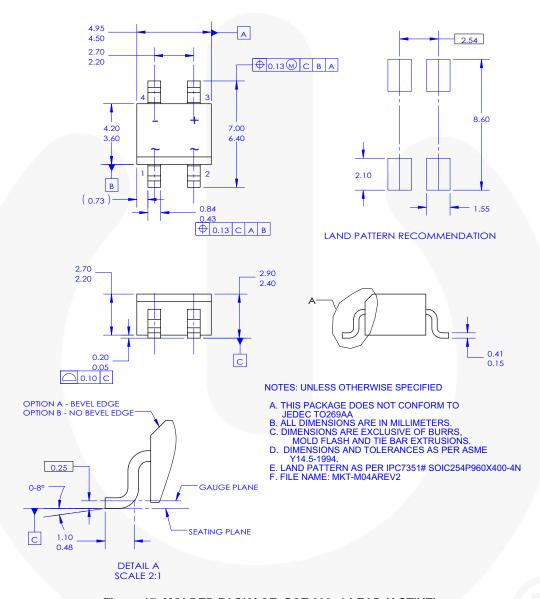


Figure 17. MOLDED PACKAGE, SOT-223, 4-LEAD (ACTIVE)

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Physical Dimensions (continued)

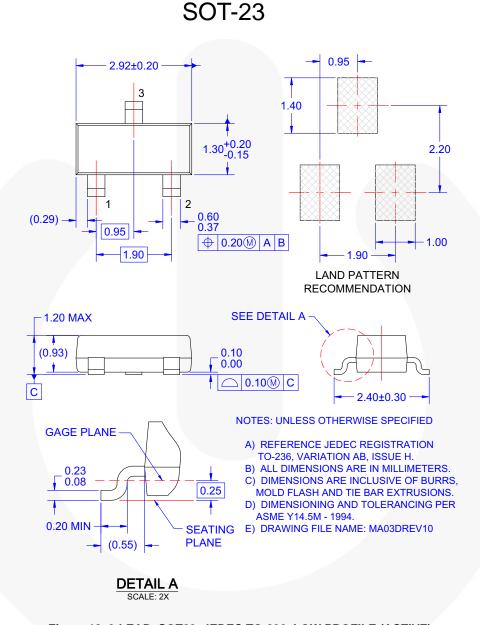


Figure 18. 3-LEAD, SOT23, JEDEC TO-236, LOW PROFILE (ACTIVE)

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